

40V COMPLEMENTARY DUAL ENHANCEMENT MODE MOSFET

Product Summary

Device	V _{(BR)DSS}	R _{DS(on)} Max	I _D T _A = +25°C
Q1	40V	28mΩ @ V _{GS} = 10V	7.2A
		49mΩ @ V _{GS} = 4.5V	5.4A
Q2	-40V	50mΩ @ V _{GS} = -10V	-5.2A
		79mΩ @ V _{GS} = -4.5V	-4.7A

Description

This MOSFET has been designed to minimize the on-state resistance and yet maintain superior switching performance, making it ideal for high efficiency power management applications.


Applications

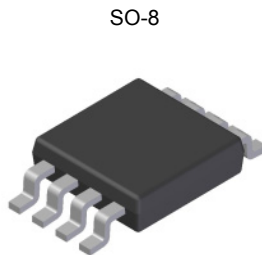
- Motor Control
- Backlighting
- DC-DC Converters
- Power Management Functions

Features and Benefits

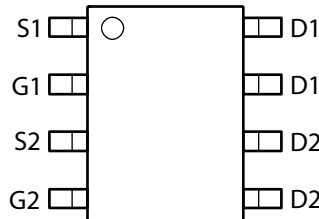
- Low On-Resistance
- Fast Switching Speed
- **Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

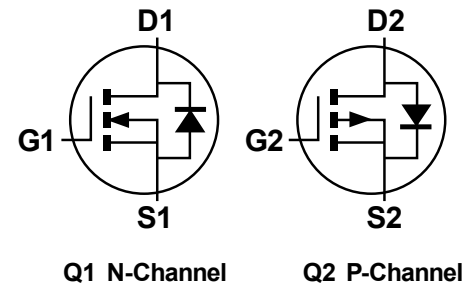
- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See diagram below
- Terminals: Finish - Matte Tin annealed over Copper lead frame. Solderable per MIL-STD-202, Method 208 
- Weight: 0.074 grams (approximate)



Top View



Top View



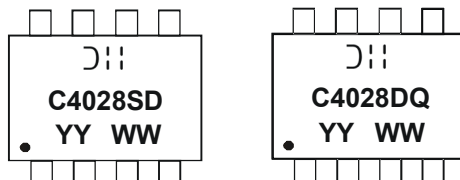
Equivalent Circuit

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
DMC4028SSD-13	Standard	SO-8	2500 / Tape & Reel
DMC4028SSDQ-13	Automotive	SO-8	2500 / Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



011 = Manufacturer's Marking
 C4028SD = Product Type Marking Code for DMC4028SSD-13
 C4028DQ = Product Type Marking Code for DMC4028SSDQ-13
 YYWW = Date Code Marking
 YY = Year (ex: 09 = 2009)
 WW = Week (01 - 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

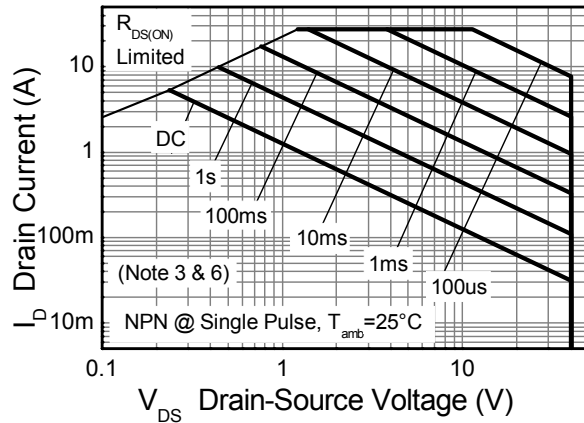
Characteristic			Symbol	N-Channel - Q1	P-Channel - Q2	Units
Drain-Source Voltage			V _{DSS}	40	-40	V
Gate-Source Voltage		(Note 5)	V _{GSS}	±20	±20	V
Continuous Drain Current	V _{GS} = 10V	(Notes 7 & 9)	I _D	7.2	5.2	A
		T _A = 70°C (Notes 7 & 9)		5.5	4.2	
		(Notes 6 & 9)		5.4	4	
		(Notes 6 & 10)		6.5	4.8	
Pulsed Drain Current	V _{GS} = 10V	(Notes 7 & 9)	I _{DM}	27.3	20.4	A
Continuous Source Current (Body diode)		(Notes 7 & 9)	I _S	3.35	3.15	A
Pulsed Source Current (Body diode)		(Notes 8 & 9)	I _{SM}	27.3	20.4	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

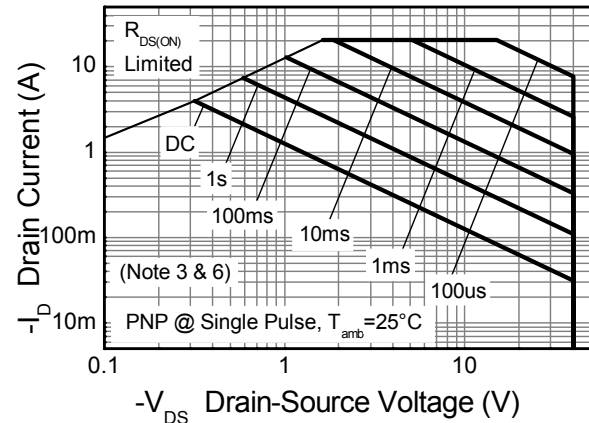
Characteristic		Symbol	N-Channel - Q1	P-Channel - Q2	Unit
Power Dissipation Linear Derating Factor	(Notes 6 & 9)	P _D	1.25 10		W mW/°C
	(Notes 6 & 10)		1.8 14.3		
	(Notes 7 & 9)		2.16 17.2		
	(Notes 6 & 9)		100		
Thermal Resistance, Junction to Ambient	(Notes 6 & 10)	R _{θJA}	70		°C/W
	(Notes 7 & 9)		58		
	(Notes 9 & 11)		53	53	
Thermal Resistance, Junction to Lead		R _{θJL}	53	53	
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150		°C

- Notes:
- AEC-Q101 V_{GS} maximum is ±16V.
 - For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
 - Same as note (5), except the device is measured at t ≤ 10 sec.
 - Same as note (5), except the device is pulsed with D= 0.02 and pulse width 300 μs. The pulse current is limited by the maximum junction temperature.
 - For a dual device with one active die.
 - For a device with two active die running at equal power.
 - Thermal resistance from junction to solder-point (at the end of the drain lead).

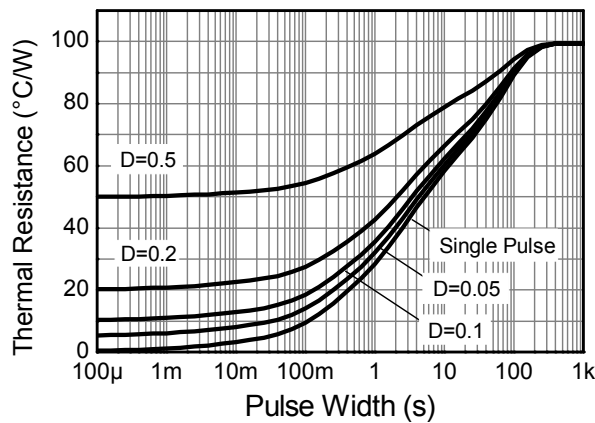
Thermal Characteristics



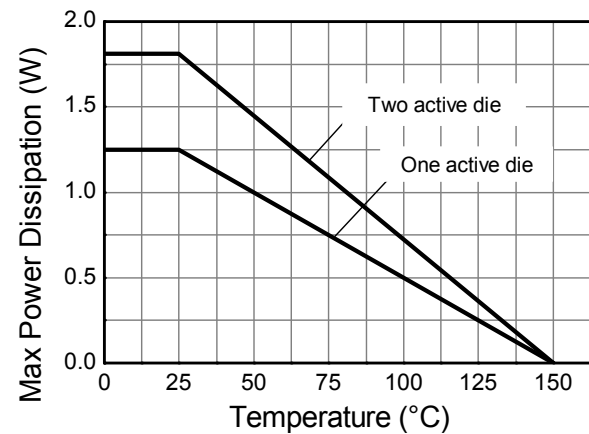
N-channel Safe Operating Area



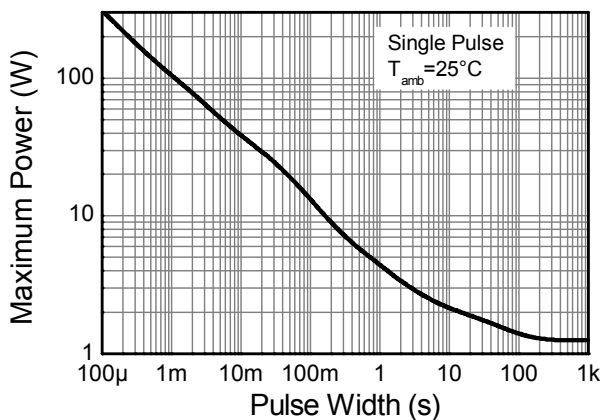
P-channel Safe Operating Area



Transient Thermal Impedance



Derating Curve



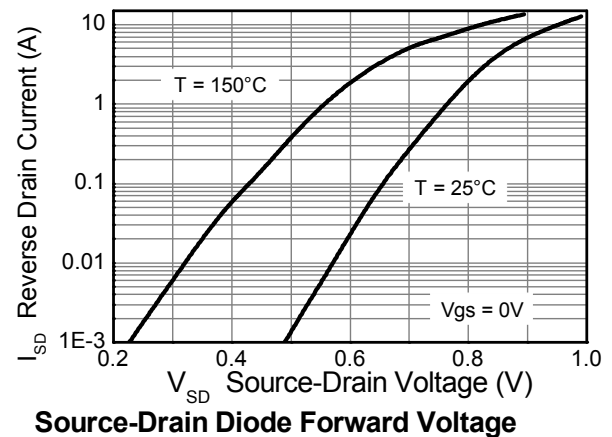
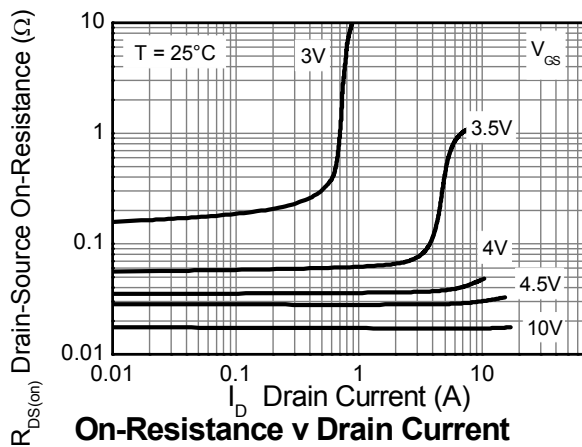
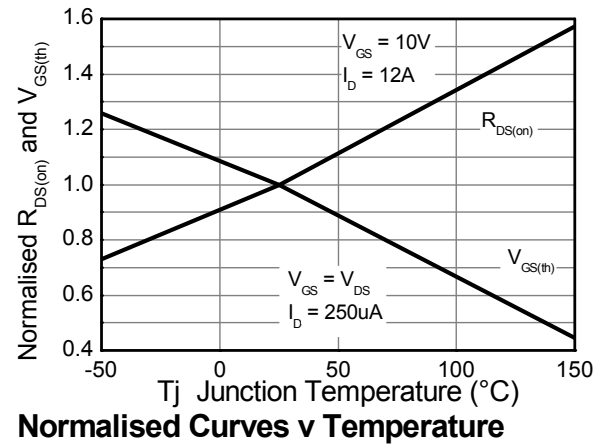
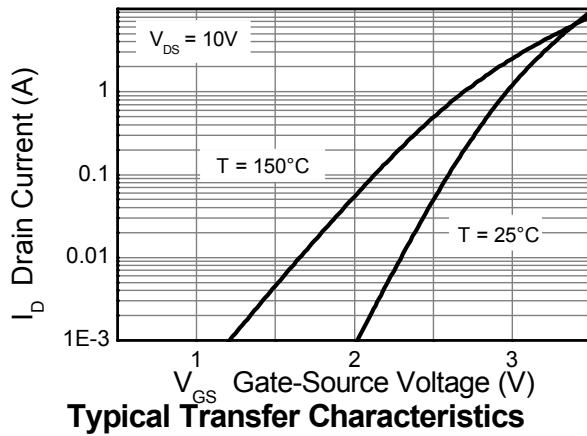
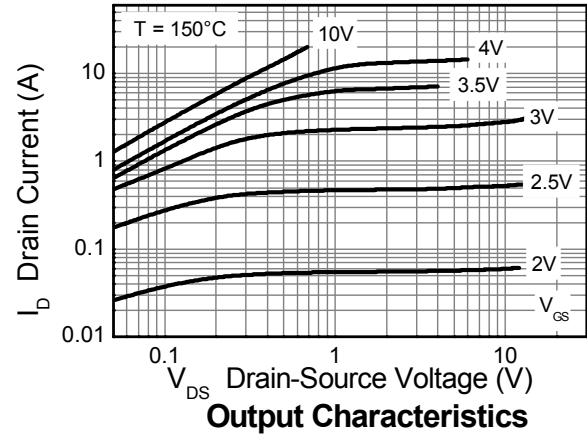
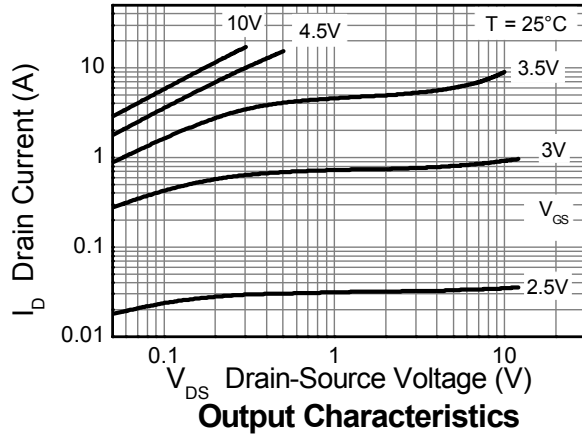
Pulse Power Dissipation

Electrical Characteristics – Q1 N-Channel (@T_A = +25°C, unless otherwise specified.)

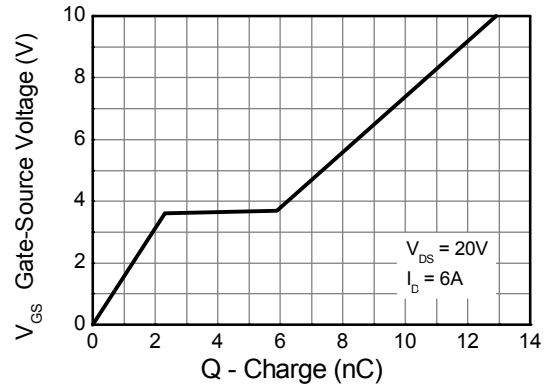
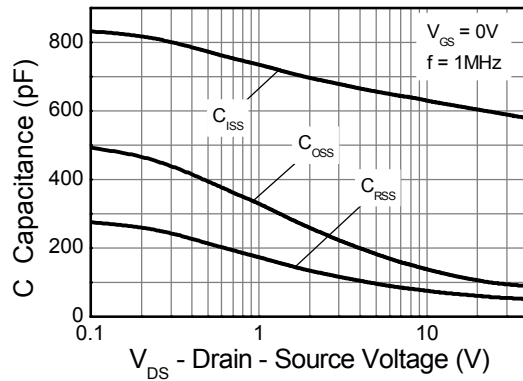
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition	
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	BV _{DSS}	40	—	—	V	I _D = 250μA, V _{GS} = 0V	
Zero Gate Voltage Drain Current	I _{DSS}	—	—	0.5	μA	V _{DS} = 40V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	—	—	±100	nA	V _{GS} = ±20V, V _{DS} = 0V	
ON CHARACTERISTICS							
Gate Threshold Voltage	V _{GS(th)}	1.0	—	3.0	V	I _D = 250μA, V _{DS} = V _{GS}	
Static Drain-Source On-Resistance (Note 12)	R _{DS (ON)}	—	0.018	0.028	Ω	V _{GS} = 10V, I _D = 6A	
			0.033	0.049		V _{GS} = 4.5V, I _D = 5A	
Forward Transconductance (Notes 12 & 13)	g _{fs}	—	22.8	—	S	V _{DS} = 15V, I _D = 6A	
Diode Forward Voltage (Note 12)	V _{SD}	—	0.845	1.1	V	I _S = 6A, V _{GS} = 0V	
Reverse recovery time (Note 13)	t _{rr}		135	—	ns	I _S = 6A, di/dt = 100A/μs	
Reverse recovery charge (Note 13)	Q _{rr}	—	799	—	nC		
DYNAMIC CHARACTERISTICS (Note 13)							
Input Capacitance	C _{iss}	—	604	—	pF	V _{DS} = 20V, V _{GS} = 0V f = 1MHz	
Output Capacitance	C _{oss}	—	106	—	pF		
Reverse Transfer Capacitance	C _{rss}	—	59.6	—	pF		
Total Gate Charge (Note 14)	Q _g	—	6.5	—	nC	V _{GS} = 4.5V	V _{DS} = 20V I _D = 6A
Total Gate Charge (Note 14)	Q _g	—	12.9	—	nC	V _{GS} = 10V	
Gate-Source Charge (Note 14)	Q _{gs}	—	2.3	—	nC		
Gate-Drain Charge (Note 14)	Q _{gd}	—	3.6	—	nC		
Turn-On Delay Time (Note 14)	t _{D(on)}	—	4.2	—	ns	V _{DD} = 20V, V _{GS} = 10V I _D = 6A, R _G ≅ 6.0Ω	
Turn-On Rise Time (Note 14)	t _r	—	12.4	—	ns		
Turn-Off Delay Time (Note 14)	t _{D(off)}	—	13.8	—	ns		
Turn-Off Fall Time (Note 14)	t _f	—	10.7	—	ns		

Notes: 12. Measured under pulsed conditions. Pulse width ≤ 300μs; duty cycle ≤ 2%
13. For design aid only, not subject to production testing.
14. Switching characteristics are independent of operating junction temperatures.

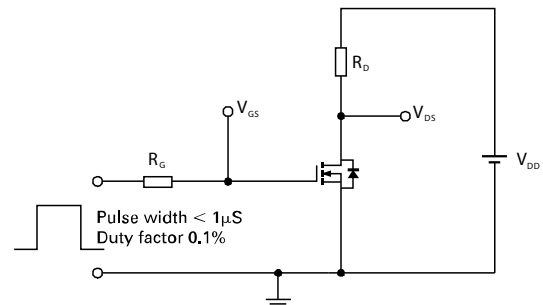
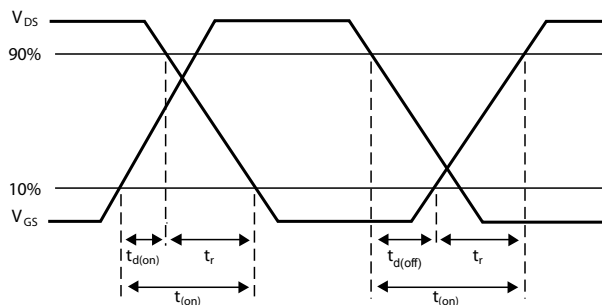
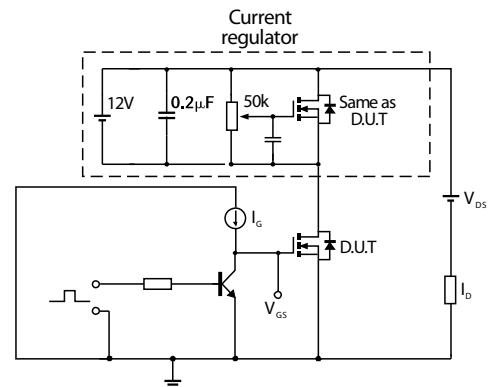
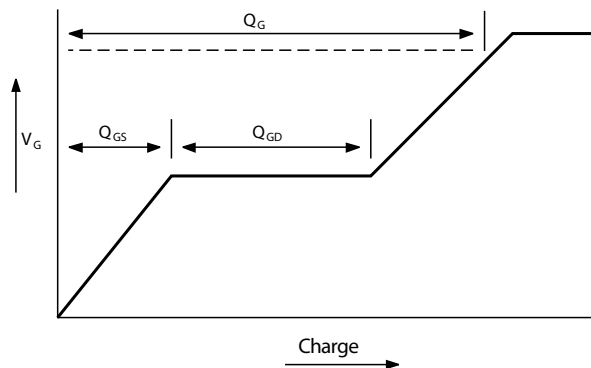
Typical Characteristics – Q1 N-Channel



Typical Characteristics – Q1 N-Channel - (cont.)



Test Circuits – Q1 N-Channel

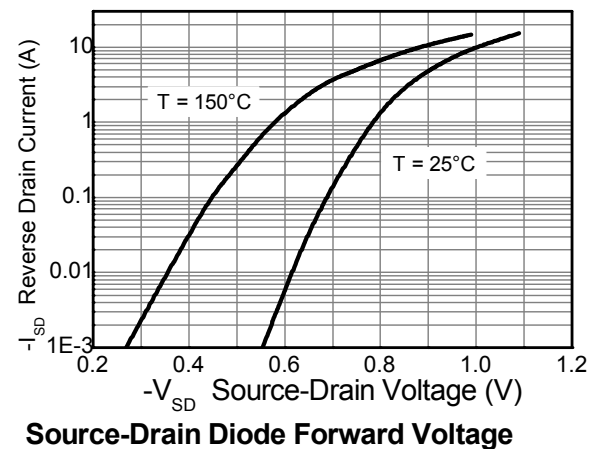
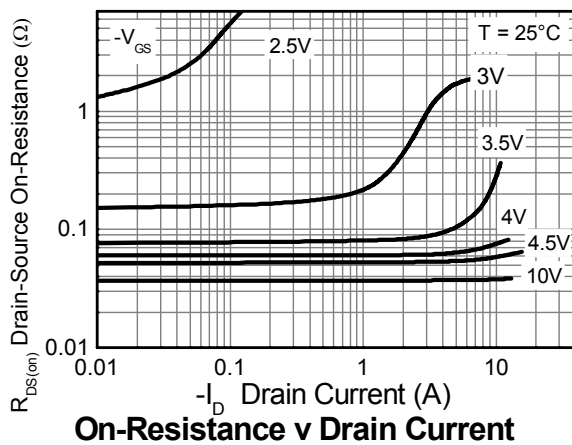
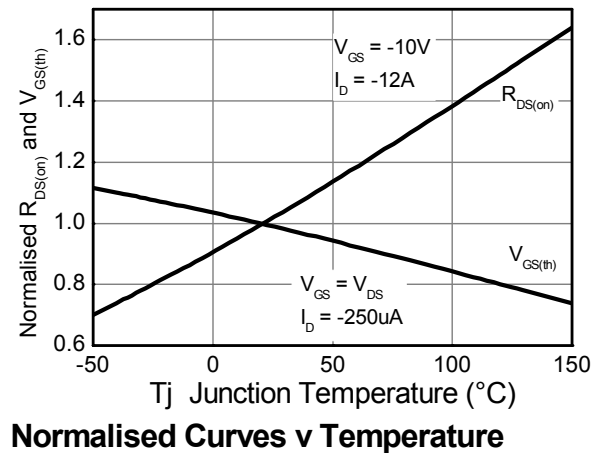
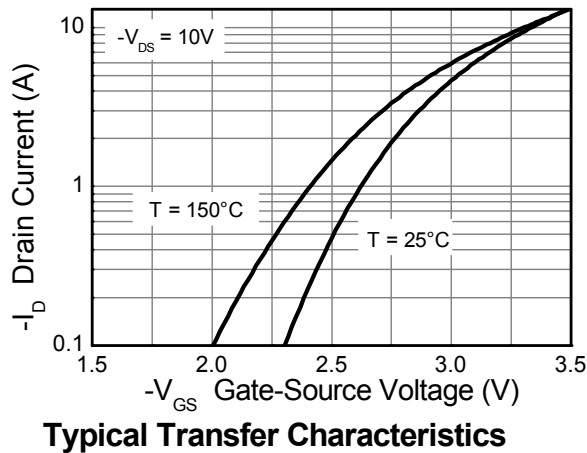
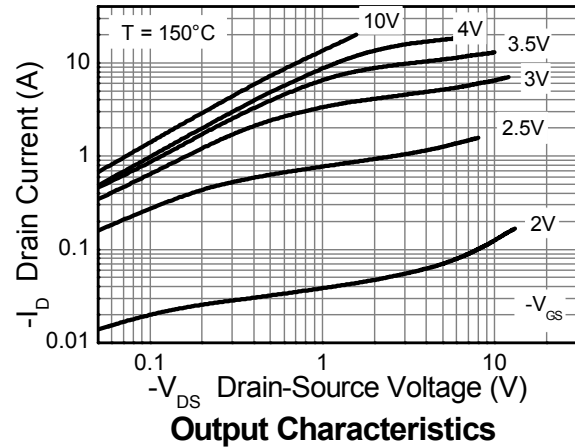
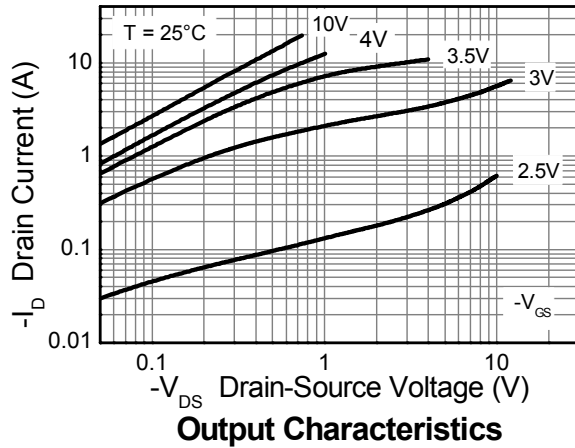


Electrical Characteristics – Q2 P-Channel (@T_A = +25°C, unless otherwise specified.)

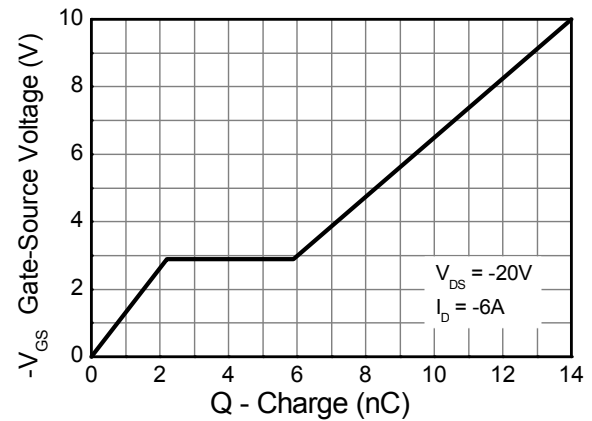
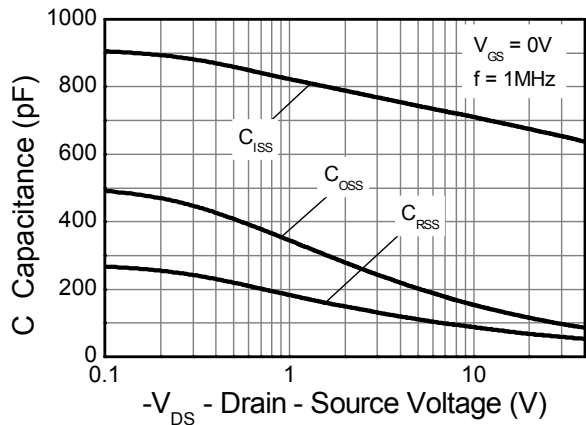
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition	
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	BV _{DSS}	-40	—	—	V	I _D = -250 μA, V _{GS} = 0V	
Zero Gate Voltage Drain Current	I _{DSS}	—	—	-0.5	μA	V _{DS} = -40V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	—	—	±100	nA	V _{GS} = ±20V, V _{DS} = 0V	
ON CHARACTERISTICS							
Gate Threshold Voltage	V _{GS(th)}	-1.0	—	-3.0	V	I _D = -250 μA, V _{DS} = V _{GS}	
Static Drain-Source On-Resistance (Note 12)	R _{DS(ON)}	—	0.039	0.050	Ω	V _{GS} = -10V, I _D = -6A	
			0.060	0.079		V _{GS} = -4.5V, I _D = -5A	
Forward Transconductance (Notes 12 & 13)	g _{fs}	—	16.6	—	S	V _{DS} = -15V, I _D = -6A	
Diode Forward Voltage (Note 13)	V _{SD}	—	~0.865	-1.1	V	I _S = -6A, V _{GS} = 0V	
Reverse Recovery Time (Note 13)	t _{rr}	—	138	—	ns	I _S = -6A, di/dt = 100A/μs	
Reverse Recovery Charge (Note 13)	Q _{rr}	—	841	—	nC		
DYNAMIC CHARACTERISTICS (Note 13)							
Input Capacitance	C _{iSS}	—	674	—	pF	V _{DS} = -20V, V _{GS} = 0V f = 1MHz	
Output Capacitance	C _{oss}	—	115	—	pF		
Reverse Transfer Capacitance	C _{rSS}	—	67.7	—	pF		
Total Gate Charge (Note 14)	Q _g	—	7.0	—	nC	V _{GS} = -4.5V	V _{DS} = -20V I _D = -6A
Total Gate Charge (Note 14)	Q _g	—	14	—	nC	V _{GS} = -10V	
Gate-Source Charge (Note 14)	Q _{gs}	—	2.2	—	nC		
Gate-Drain Charge (Note 14)	Q _{gd}	—	3.7	—	nC		
Turn-On Delay Time (Note 14)	t _{D(on)}	—	2.3	—	ns	V _{DD} = -20V, V _{GS} = -10V I _D = -6A, R _G ≅ 6.0Ω	
Turn-On Rise Time (Note 14)	t _r	—	14.1	—	ns		
Turn-Off Delay Time (Note 14)	t _{D(off)}	—	25.1	—	ns		
Turn-Off Fall Time (Note 14)	t _f	—	14.3	—	ns		

Notes: 12. Measured under pulsed conditions. Pulse width ≤ 300μs; duty cycle ≤ 2%
13. For design aid only, not subject to production testing.
14. Switching characteristics are independent of operating junction temperatures.

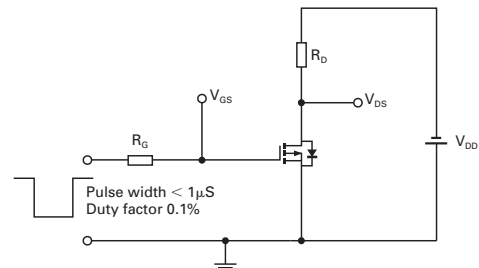
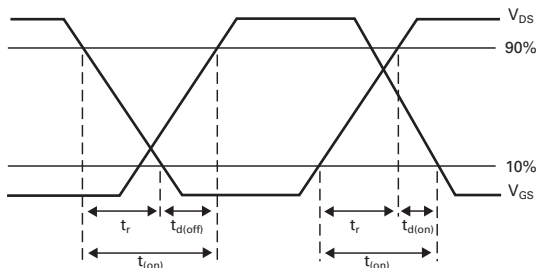
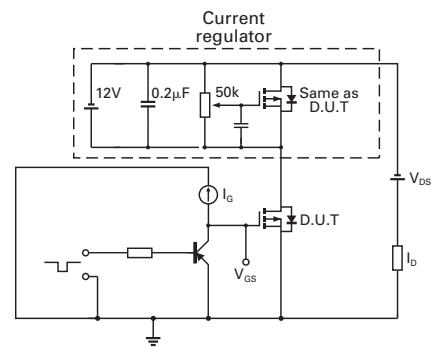
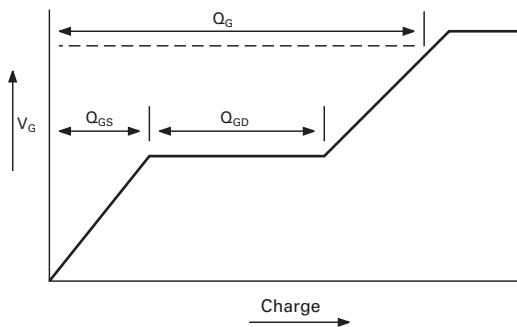
Typical Characteristics – Q2 P-Channel



Typical Characteristics – Q2 P-Channel – (cont.)

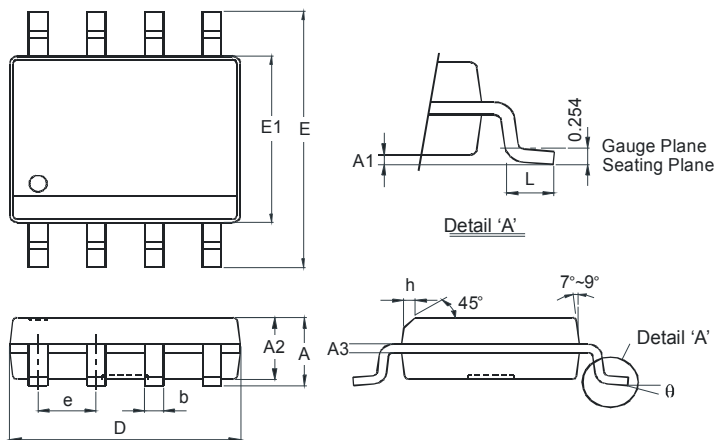


Test Circuits – Q2 P-Channel



Package Outline Dimensions

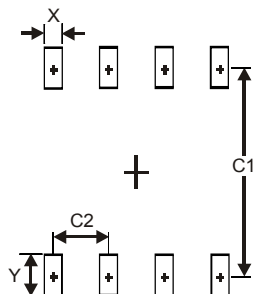
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.



SO-8		
Dim	Min	Max
A	-	1.75
A1	0.10	0.20
A2	1.30	1.50
A3	0.15	0.25
b	0.3	0.5
D	4.85	4.95
E	5.90	6.10
E1	3.85	3.95
e	1.27 Typ	
h	-	0.35
L	0.62	0.82
θ	0°	8°
All Dimensions in mm		

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
X	0.60
Y	1.55
C1	5.4
C2	1.27

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2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.

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